

Halar® 350LC

ethylene chlorotrifluoroethylene copolymer

General			
Material Status	 Commercial: Active 		
Availability	Africa & Middle EastAsia PacificEurope	Latin AmericaNorth America	
Features	 Medium Viscosity 		
Forms	 Pellets 		
Processing Method	 Extrusion 	 Injection Molding 	
Physical		Typical Value Unit	Test method
Density / Specific Gravity		1.68	ASTM D792
Melt Mass-Flow Rate (MFR) (275°C/216 kg)	4.0 g/10 min	ASTM D1238
Molding Shrinkage - Flow	270 072.10 kg)	2.5 %	ASTM D955
Water Absorption (Equilibrium)		< 0.10 %	ASTM D533
Water Absorption (Equilibrial	,	. 0.10 70	AOTIVI DO70
Mechanical		Typical Value Unit	Test method
Tensile Modulus¹ (23°C)		1660 MPa	ASTM D638
Tensile Strength ¹			ASTM D638
Yield, 23°C		30.0 MPa	
Break, 23°C		54.0 MPa	
Tensile Elongation ¹			ASTM D638
Yield, 23°C		5.0 %	
Break, 23°C		250 %	
Flexural Modulus 2 (23°C)		1690 MPa	ASTM D790
Flexural Strength 2 (23°C)		47.0 MPa	ASTM D790
Coefficient of Friction			ASTM D1894
vs. Itself - Dynamic		0.20	
vs. Itself - Static		0.20	
Impact		Typical Value Unit	Test method
Notched Izod Impact		Typical value of the	ASTM D256
-40°C, 3.20 mm		95 J/m	AOTH B200
23°C, 3.20 mm		No Break	
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Hardness		Typical Value Unit	Test method
Rockwell Hardness (R-Scale)		90	ASTM D785
Durometer Hardness (Shore	D)	75	ASTM D2240

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Thermal	Typical Value Unit	Test method
Deflection Temperature Under Load		ASTM D648
0.45 MPa, Unannealed	90.0 °C	
1.8 MPa, Unannealed	65.0 °C	
Brittleness Temperature	< -76.0 °C	ASTM D746A
Glass Transition Temperature	85.0 °C	DMA
Melting Temperature	242 °C	ASTM D3418
Peak Crystallization Temperature (DSC)	222 °C	ASTM D3418
CLTE - Flow	1.0E-4 cm/cm/°C	ASTM D696
Specific Heat (23°C)	962 J/kg/°C	ASTM D3418
Thermal Conductivity (40°C)	0.15 W/m/K	ASTM C177
Crystallization Heat	40.0 J/g	ASTM D3418
Heat of Fusion	42.0 J/g	ASTM D3418
Thermal Stability - 1% mass loss, N2	405 °C	TGA
Electrical	Typical Value Unit	Test method
Volume Resistivity 3 (23°C)	5.5E+16 ohms·cm	ASTM D257
Dielectric Strength (23°C, 3.20 mm)	14 kV/mm	ASTM D149
Dielectric Constant (23°C, 1 MHz)	2.57	ASTM D150
Flammability	Typical Value Unit	Test method
Flame Rating	V-0	UL 94
Oxygen Index	52 %	ASTM D2863

Additional Information

Storage and Handling

 Halar® melt processable fluoropolymer resins can be stored without shelf life issues when kept in a clean and dry area at ambient temperatures. Opened containers should be tightly resealed to prevent any contamination.

Notes

Typical properties: these are not to be construed as specifications.

- ¹ 50 mm/min
- ² 2.5 mm/min
- ³ 50% RH

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